

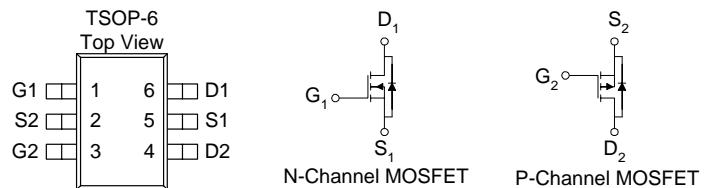
N & P-Channel 32-V (D-S) MOSFET

These miniature surface mount MOSFETs utilize a high cell density trench process to provide low $r_{DS(on)}$ and to ensure minimal power loss and heat dissipation. Typical applications are DC-DC converters and power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

- Low $r_{DS(on)}$ provides higher efficiency and extends battery life
- Low thermal impedance copper leadframe TSOP-6 saves board space
- Fast switching speed
- High performance trench technology

PRODUCT SUMMARY

V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)
30	0.063 @ $V_{GS} = 10V$	3.7
	0.090 @ $V_{GS} = 4.5V$	3.1
-30	0.112 @ $V_{GS} = -10V$	-2.7
	0.172 @ $V_{GS} = -4.5V$	-2.2



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ UNLESS OTHERWISE NOTED)

Parameter	Symbol	N-Channel	P-Channel	Units
Drain-Source Voltage	V_{DS}	30	-30	V
Gate-Source Voltage	V_{GS}	± 20	± 20	
Continuous Drain Current ^a	I_D	3.7	-2.7	A
		2.9	-2.1	
Pulsed Drain Current ^b	I_{DM}	8	-8	
Continuous Source Current (Diode Conduction) ^a	I_S	1.05	-1.05	A
Power Dissipation ^a	P_D	1.15		W
		0.7		
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 150		°C

THERMAL RESISTANCE RATINGS

Parameter	Symbol	N-Channel		P-Channel		Unit
		Typ	Max	Typ	Max	
Maximum Junction-to-Ambient ^a	R_{thJA}	93	110	93	110	°C/W
		130	150	130	150	

Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature

SPECIFICATIONS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

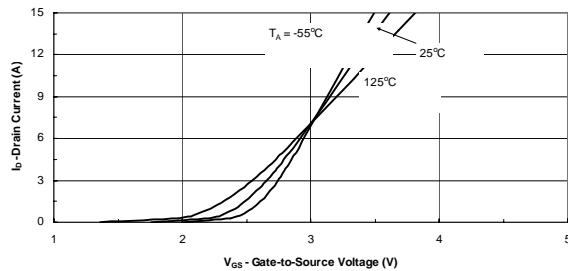
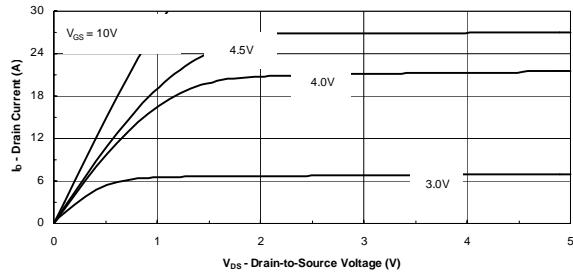
Parameter	Symbol	Test Conditions	Limits				Unit
			Ch	Min	Typ	Max	
Static							
Gate-Threshold Voltage	$V_{GS(\text{th})}$	$VGS = VDS, ID = 250 \mu\text{A}$	N	1	1.6	2.5	V
		$VGS = VDS, ID = -250 \mu\text{A}$	P	-1	-1.6	-2.5	
Gate-Body Leakage Current	I_{GSS}	$VDS = 0 \text{ V}, VGS = 20 \text{ V}$	N		4.5nA	100	μA
		$VDS = 0 \text{ V}, VGS = -20 \text{ V}$	P		-4.5nA	-100	
Zero Gate Voltage Drain Current	I_{DSS}	$VDS = 24 \text{ V}, VGS = 0 \text{ V}$	N		12nA	1	μA
		$VDS = -24 \text{ V}, VGS = 0 \text{ V}$	P		-12nA	-1	
		$VDS = 24 \text{ V}, VGS = 0 \text{ V}, T_J = 55^\circ\text{C}$	N			10	μA
		$VDS = -24 \text{ V}, VGS = 0 \text{ V}, T_J = 55^\circ\text{C}$	P			-10	
On-State Drain Current ^A	$I_{D(\text{on})}$	$V_{DS} = 5 \text{ V}, VGS = 10 \text{ V}$	N	5			A
		$V_{DS} = -5 \text{ V}, VGS = -10 \text{ V}$	P	-5			
Drain-Source On-Resistance ^A	$r_{DS(\text{on})}$	$VGS = 10 \text{ V}, ID = 3.7 \text{ A}$	N		0.057	0.063	Ω
		$VGS = -10 \text{ V}, ID = 3.1 \text{ A}$	P		0.100	0.112	
		$VGS = 4.5 \text{ V}, ID = 2.7 \text{ A}$	N		0.075	0.090	
		$VGS = -4.5 \text{ V}, ID = -2.2 \text{ A}$	P		0.148	0.172	
Forward Tranconductance ^A	g_{fs}	$V_{DS} = 5 \text{ V}, I_D = 3.7 \text{ A}$	N		10		S
		$V_{DS} = -5 \text{ V}, I_D = 3.1 \text{ A}$	P		5		
Diode Forward Voltage ^A	V_{SD}	$I_S = 1.05 \text{ A}, VGS = 0 \text{ V}$	N		0.80		S
		$I_S = -1.05 \text{ A}, VGS = 0 \text{ V}$	P		-0.83		
Dynamic^b							
Total Gate Charge	Q_g	N-Channel $V_{DS}=15\text{V}, V_{GS}=4.5\text{V}, I_D=2.7\text{A}$ P-Channel $V_{DS}=-15\text{V}, V_{GS}=-4.5\text{V}, ID=-3.1\text{A}$	N		2.2	5	nC
Gate-Source Charge	Q_{gs}		P		3.8	8	
Gate-Drain Charge	Q_{gd}		N		0.5	1	
Input Capacitance	C_{iss}		P		0.6	2	
Output Capacitance	C_{oss}		N		0.8	2	
Reverse Transfer Capacitance	C_{rss}		P		1.5	3	
Turn-On Delay Time	$t_{d(on)}$	N-Channel $V_{DD}=15\text{V}, V_{GS}=4.5\text{V}, ID=1\text{A}$, $R_{GEN}=15\Omega$, P-Channel $VDD=-15\text{V}, VGS=-4.5\text{V}, ID=-1\text{A}$ $RGEN=15\Omega$	N		184	400	pF
Rise Time	t_r		P		378	800	
Turn-Off Delay Time	$t_{d(off)}$		N		62	200	
Fall-Time	t_f		P		126	300	
			N		30	200	
			P		52	300	
			N		5	10	nS
			P		5	10	

Notes

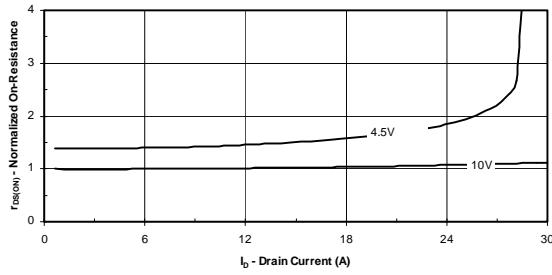
- a. Pulse test: PW <= 300us duty cycle <= 2%.
- b. Guaranteed by design, not subject to production testing.

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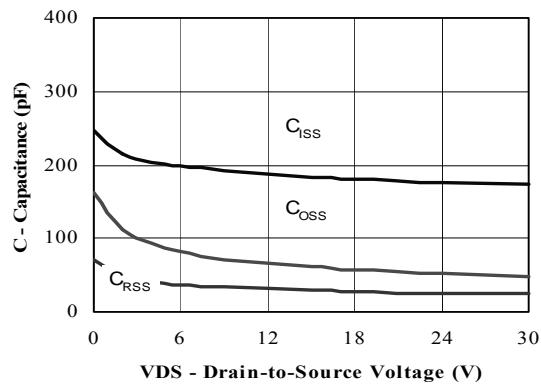
Typical Electrical Characteristics (N-Channel)



Output Characteristics

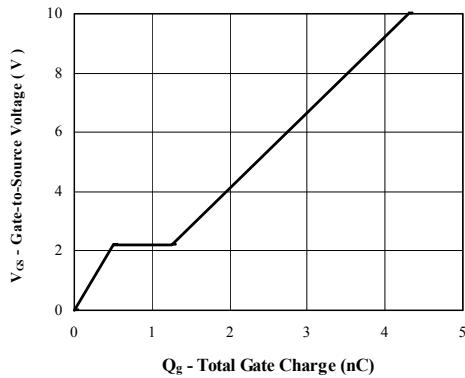


Transfer Characteristics

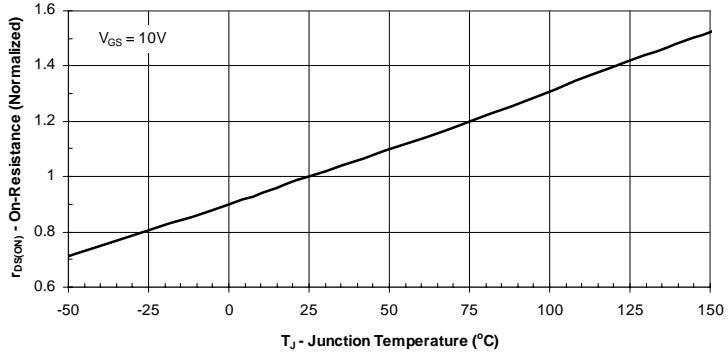


On-Resistance vs. Drain Current

Capacitance

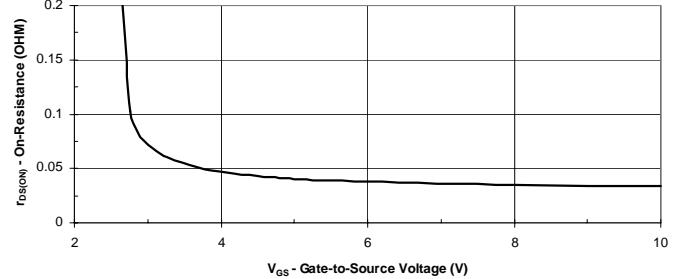
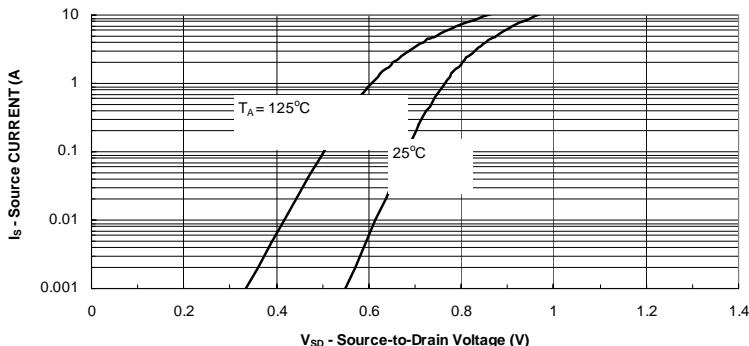


Gate Charge

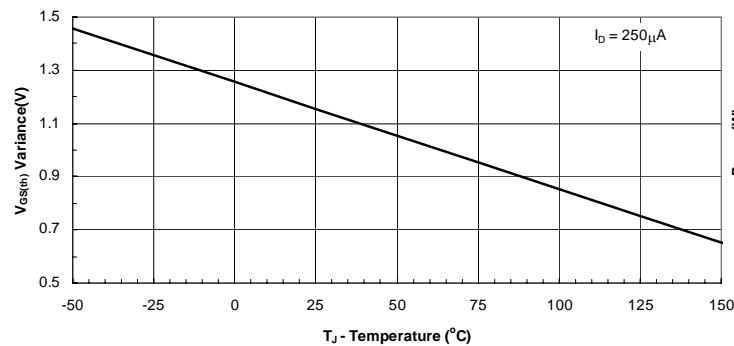


On-Resistance vs. Junction Temperature

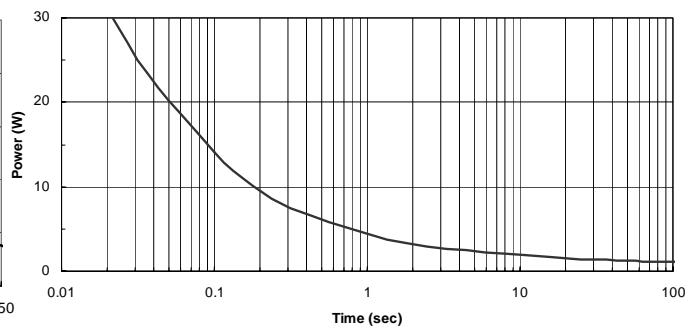
Typical Electrical Characteristics (N-Channel)



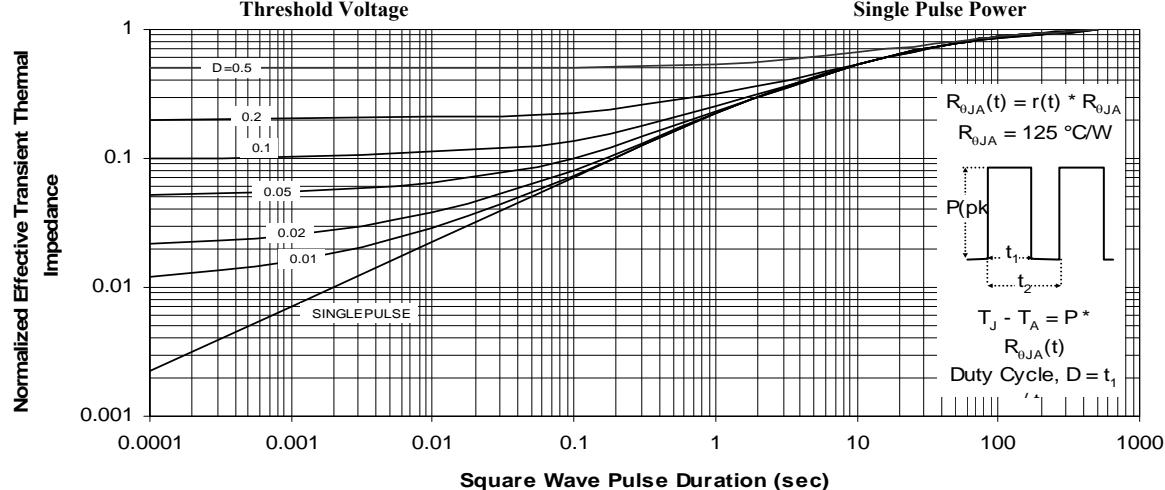
Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to Source Voltage

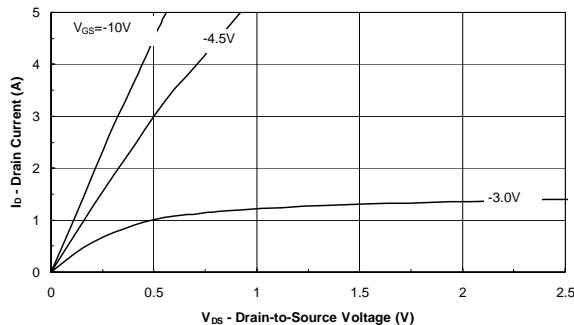


Threshold Voltage

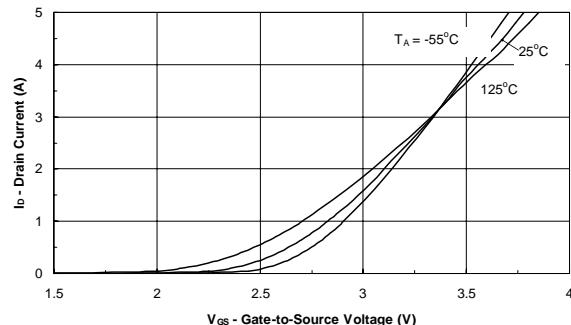


Normalized Thermal Transient Impedance, Junction-to-Ambient

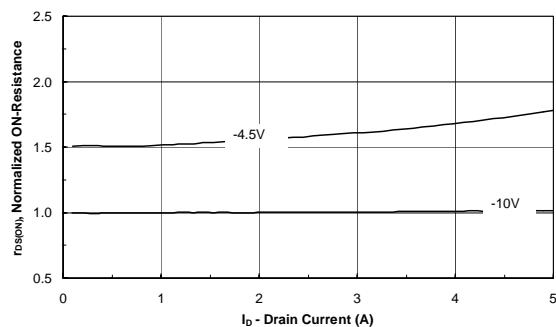
Typical Electrical Characteristics (P-Channel)



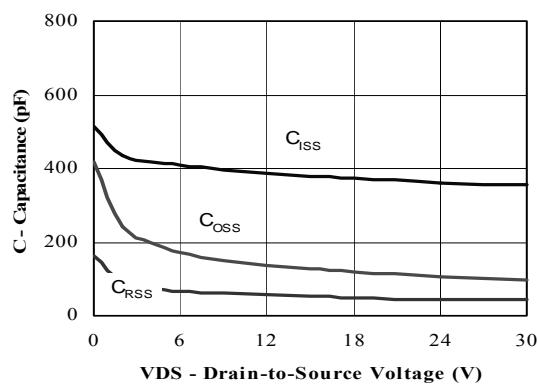
Output Characteristics



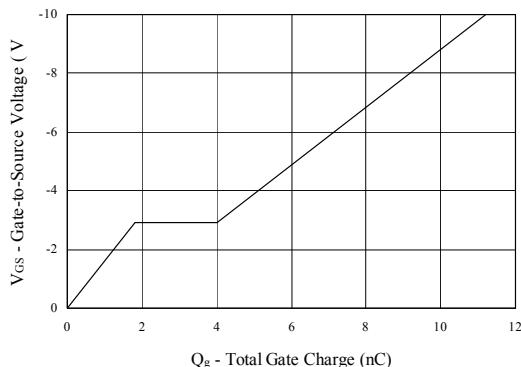
Transfer Characteristics



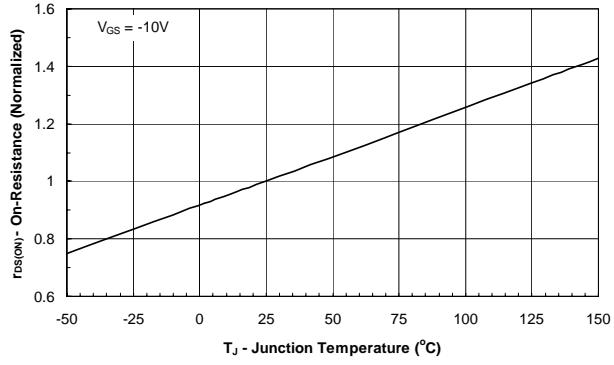
On-Resistance vs. Drain Current



Capacitance

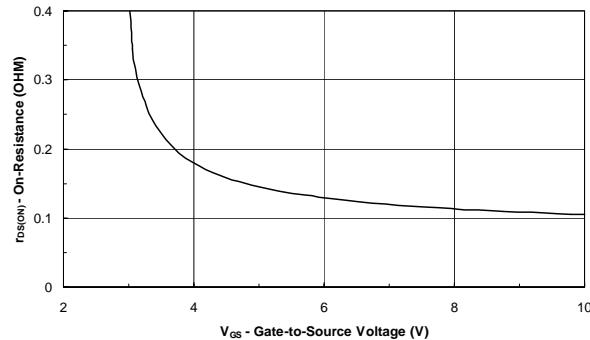
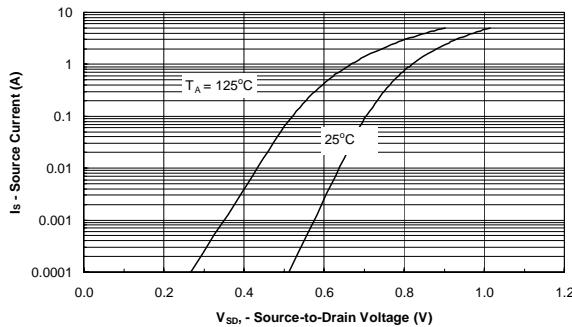


Gate Charge

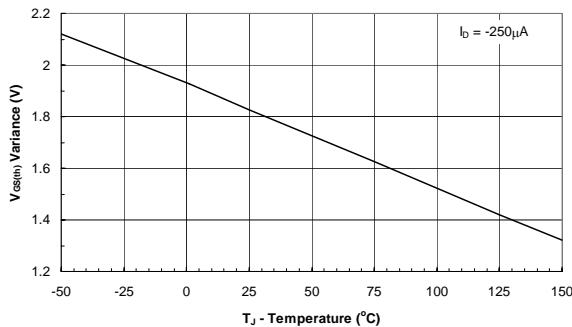


On-Resistance vs. Junction Temperature

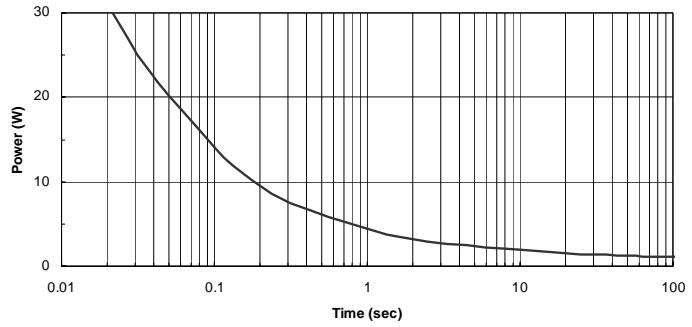
Typical Electrical Characteristics (P-Channel)



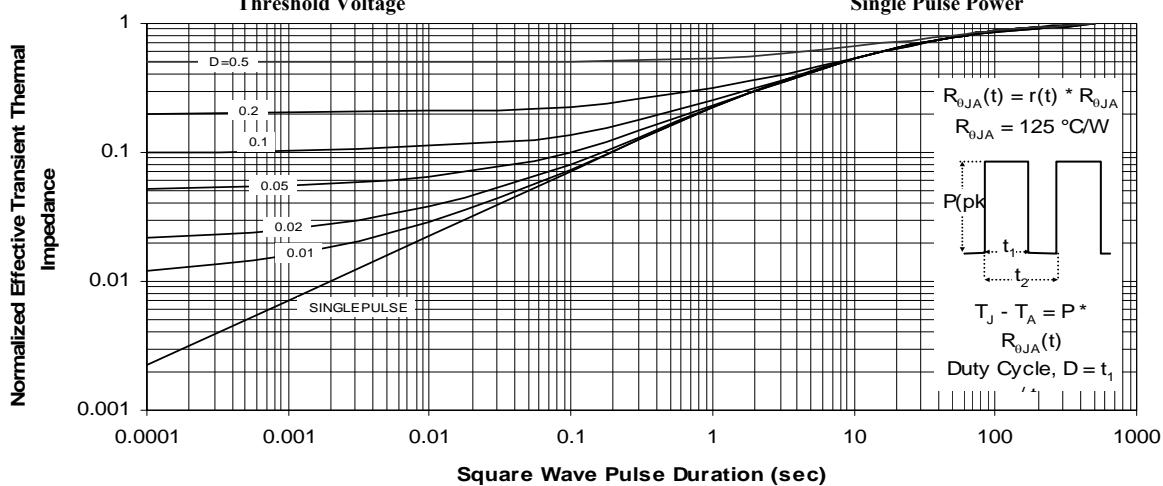
Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to Source Voltage



Threshold Voltage

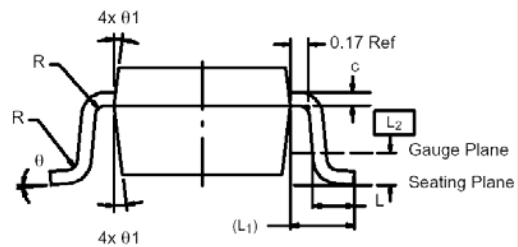
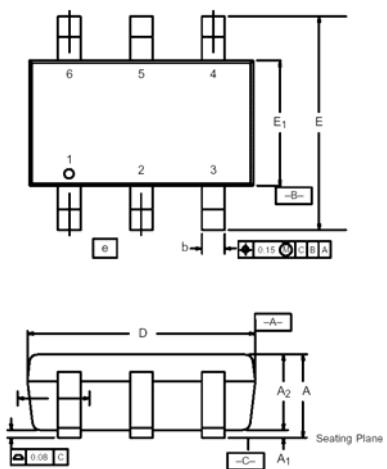


Single Pulse Power

Normalized Thermal Transient Impedance, Junction-to-Ambient

Package Information

TSOP-6: 6LEAD



Dim	MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max
A	0.91	—	1.10	0.036	—	0.043
A₁	0.01	—	0.10	0.0004	—	0.004
A₂	0.84	—	1.00	0.033	0.038	0.039
b	0.30	0.32	0.45	0.012	0.013	0.018
c	0.10	0.15	0.20	0.004	0.006	0.008
D	2.95	3.05	3.10	0.116	0.120	0.122
E	2.70	2.85	2.98	0.106	0.112	0.117
E₁	1.55	1.65	1.70	0.061	0.065	0.067
e	1.00 BSC			0.0394 BSC		
L	0.35	—	0.50	0.014	—	0.020
L₁	0.60 Ref			0.024 Ref		
L₂	0.25 BSC			0.010 BSC		
R	0.10	—	—	0.004	—	—
θ	0°	4°	8°	0°	4°	8°
θ₁	7° Nom			7° Nom		